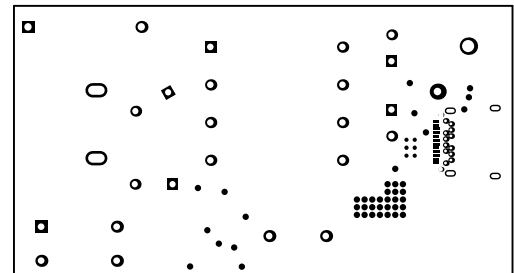
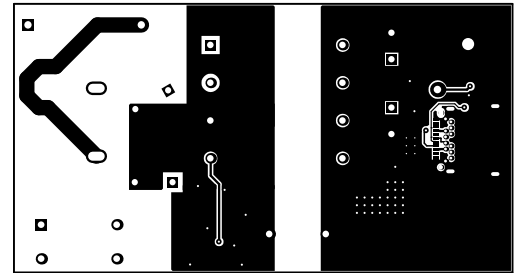


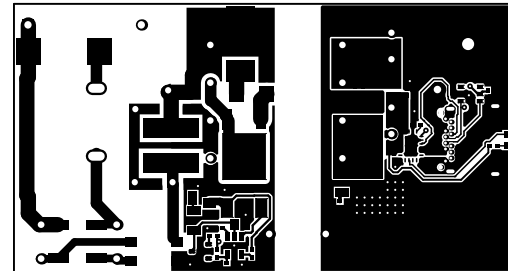
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11124	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #:		
PLOT NAME = Top Overlay	GENERATED : 8/24/2015 1:34:36 PM	TEXAS INSTRUMENTS	



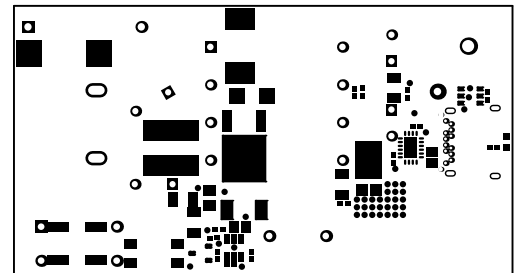
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11124	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #:		
PLOT NAME = Top Solder Mask	GENERATED : 8/24/2015 1:34:36 PM	TEXAS INSTRUMENTS	



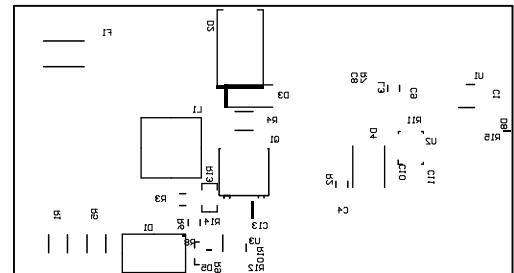
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11124	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #:		
PLOT NAME = Top Layer	GENERATED : 8/24/2015 1:34:37 PM	TEXAS INSTRUMENTS	



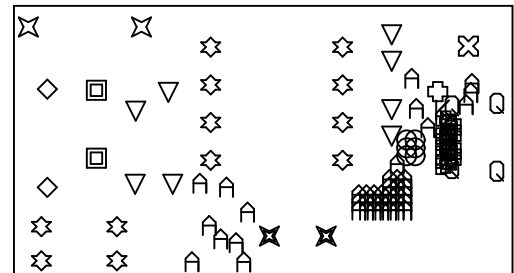
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11124	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #:		
PLOT NAME = Bottom Layer	GENERATED : 8/24/2015 1:34:38 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11124	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #:		
PLOT NAME = Bottom Solder Mask	GENERATED : 8/24/2015 1:34:39 PM	TEXAS INSTRUMENTS	

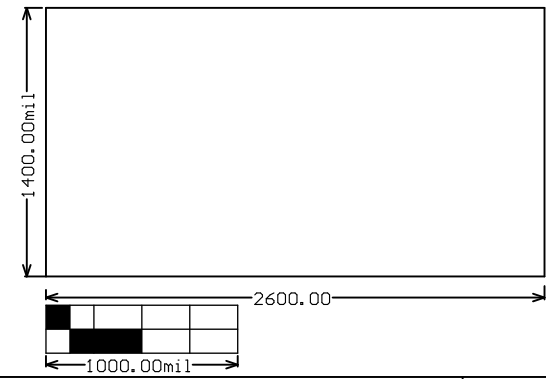


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11124	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #:		
PLOT NAME = Bottom Overlay	GENERATED : 8/24/2015 1:34:40 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
B	1	25.59mil (0.650mm)	NPTH	Round
◇	2	118.11mil (3.000mm)	NPTH	Round
K	1	25.59mil (0.650mm)	NPTH	Slot
○	6	7.87mil (0.200mm)	PTH	Round
⌘	42	12.00mil (0.305mm)	PTH	Round
⊕	12	15.75mil (0.400mm)	PTH	Round
▽	8	33.46mil (0.850mm)	PTH	Round
✕	2	35.00mil (0.889mm)	PTH	Round
☆	12	35.43mil (0.900mm)	PTH	Round
⊗	2	39.37mil (1.000mm)	PTH	Round
⊙	1	40.00mil (1.016mm)	PTH	Round
⊗	1	63.00mil (1.600mm)	PTH	Round
⊖	4	19.69mil (0.500mm)	PTH	Slot
⊞	2	47.24mil (1.200mm)	PTH	Slot
	96 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11124	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #:		
PLOT NAME = Drill Drawing	GENERATED : 8/24/2015 1:34:41 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11124	REV: B	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #:		
PLOT NAME = Board Dimensions	GENERATED : 8/24/2015 1:34:42 PM	TEXAS INSTRUMENTS	

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